

INFORMATION DISCLOSURE STATEMENT

Applicant : Michinari MIYAGAWA, et al.
App. No : 10/519,339
Filed : August 15, 2005
For : CONDUCTIVE RESIN FILM,
COLLECTOR AND MANUFACTURING
PROCESS THEREFOR
Examiner : Khanh Tuan Nguyen
Art Unit : 1796

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing three (3) references to be considered by the Examiner. Also enclosed are two (2) foreign patent references as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed after the mailing date of a final action or after the mailing date of a Notice of Allowance. This Statement is accompanied by the fee set forth in 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(1)

I hereby certify that each item of information contained in this Statement was first cited in any communication from a foreign Patent Office in a counterpart foreign application not more than three months days/months prior to the filing of this Information Disclosure Statement.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: October 28, 2008
By 

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